

## C1210X309DATAC7210

SMD Comm X8G HT150C Flex, Ceramic, 3 pF, +/-0.5 pF, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



Click here for the 3D model.

| General Information      |  |
|--------------------------|--|
| Series                   | SMD Comm X8G HT150C Flex                     |
| Style                    | SMD Chip                                     |
| Description              | SMD, MLCC, High Temperature,<br>Ultra-Stable |
| Features                 | High Temperature, Ultra-Stable               |
| RoHS                     | Yes  |
| Termination              | Flexible Termination                         |
| Marking                  | No   |
| AEC-Q200                 | No   |
| Typical Component Weight | 30 mg  |
| Shelf Life               | 78 Weeks                                     |
| MSL                      | 1  |

| ensions               |                  | Specification  |
|-----------------------|------------------|----------------|
| Size                  | 1210             | Capacitance    |
|                       | 3.3mm +/-0.4mm   | Measuremen     |
|                       | 2.6mm +/-0.3mm   | Tolerance      |
|                       | 0.78mm +/-0.20mm | Voltage DC     |
|                       | 1.5mm MIN        | Dielectric Wit |
|                       | 0.6mm +/-0.25mm  | Temperature    |
|                       |                  | Temp. Coeffi   |
| caring Specifications |                  |                |

| Packaging Specifications |                          |
|--------------------------|--------------------------|
| Packaging                | T&R, 330mm, Plastic Tape |
| Packaging Quantity       | 10000                    |

| Specifications   |  |
|--|--|
| Capacitance  | 3 pF   |
| Measurement Condition  | 1 MHz 1.0Vrms                                      |
| Tolerance  | +/-0.5 pF  |
| Voltage DC   | 250 VDC  |
| Dielectric Withstanding Voltage  | 625 VDC  |
| Temperature Range  | -55/+150°C   |
| Temp. Coefficient  | X8G  |
| Capacitance Change with<br>Reference to +25°C and 0 VDC<br>Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms                          |
| Dissipation Factor   | 0.1% 1 MHz 1.0Vrms                                 |
| Aging Rate   | 0% Loss/Decade Hour: Referee<br>Time is 1000 Hours |
| Insulation Resistance  | 100 GOhms  |

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